



September 11, 2015

Dear Valued Customer:

Re: Change of Name of International Rectifier Corporation

On January 13, 2015, Infineon Technologies AG acquired International Rectifier Corporation. As a follow-up to the acquisition, effective as of October 1, 2015 the name of International Rectifier Corporation (IR) will be changed to

Infineon Technologies Americas Corp.

This is a change in name only, and does not reflect a change in operations, facilities, entity, tax ID or registered address.

- You will continue to be served by your current account manager.
- Your checks should be mailed to the same address, and your wire transfers/ACH should be sent to the same bank account.
- Your shipments will continue to come from the same site.
- You will still deal with the same personnel you currently deal with.

As our customer you are very important to us, and we would like to make this transition as seamless as possible. Should you have any questions or concerns regarding the name change, please contact your IR representative.

We look forward to our strong continued business relationship.

Sincerely,

International Rectifier Corporation

Rainer Matern
Senior Director Accounting,
Controlling & Business Operations

Michael Cortez
Director
Accounting & Treasury

Product / Process Change Notification



Date: Monday, November 02, 2015
PCR Reference: 631
PCN Reference: 631-PCN90-Public

To Our Value Customer:

As always we appreciate your use of Infineon Technologies semiconductor products. Our commitment to customer satisfaction and continuous improvement is demonstrated by our change plans to enhance capacity, quality and reliability. This notice is to inform you of the following change:

We would like to express our sincere appreciation for your cooperation regarding the following changes, and Infineon Technologies will work closely with you to support your requirements during this transition.

Type of Change Notification:

Alternate site for the assembly and test of QFN-IC Controller products

Description of Change:

Products listed in the next page will be assembled in ASE Malaysia with Cu wire

Material	UTAC Thailand	Carsem China	ASE Malaysia (Proposed site)	Impact on Form, Fit or Function
Epoxy	8600	QMI519	QMI519	None
Wire	Au	Cu	Cu	None
Mold compound	G770HCD	G770HCD	G770HCD	None
Terminal Finish	NiPdAu	Ni/Pd/Au	Ni/Pd/Au	None

Reason for the Change:

Additional assembly and test capacity

Effect Date:

Sunday, January 31, 2016

Infineon Technologies will consider this change approved and will implement it by the effective date unless specific conditions of acceptance or data requests are provided in writing within 30 days of receipt of this notice. Please submit conditions of acceptance and data requests to the PCN coordinator listed at the end of this notice.

Impact of Change:

No impact is expected. The new Bill of Materials and Assembly site will meet the same parametric, MSL and Qualification level as the existing products. Product Datasheets will remain unchanged.

Method of Identifying Changed Product:

The part marking will be updated to include an "underscore" after the last digit of the Lot Code to identify the part as a Copper wire based device.

Products Affected:

IR Part	Description
IR3584MTRPBF	
IR3588MTRPBF	

Qualification:

Parts passed all the reliability testing requirements. Reliability qualification report is available upon request.

Supporting Data Availability:

Contact Infineon Technologies for supporting data on this change.

Contact Information:

CONTACT TYPE	NAME	PHONE	EMAIL
PCN Coordinator	Mark Ogden	+001-951-375-2334	Mark.Ogden@infineon.com
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